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Light emitting apparatus and light radiator including the same

Abstract

A light emitting apparatus includes a substrate, a plurality of light emitting structures, a window, and a reflector. The substrate has a luminous region and a non-luminous region. The plurality of light emitting structures is disposed on the luminous region of the substrate. The window has a dome shape and is disposed to cover the luminous region. The window is configured to control a traveling path of light emitted from the a plurality of light emitting structures. The reflector is configured to support the window and reflect the light emitted from the plurality of light emitting structures. The reflector has an opening that exposes the plurality of light emitting structures mounted on the substrate. A distance between two adjacent light emitting structures of the plurality of light emitting structures is 500 micrometers or less.

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Background/Summary

CROSS-REFERENCE TO RELATED APPLICATIONS (1) This application is a continuation of U.S. patent application Ser. No. 18/223,751, filed on Jul. 19, 2023, which is a continuation of U.S. patent application Ser. No. 17/562,433, filed on Dec. 27, 2021, now U.S. Pat. No. 11,761,592, which is a continuation of U.S. patent application Ser. No. 17/170,350 filed Feb. 8, 2021, now U.S. Pat. No. 11,215,329, which is a continuation of International Application No. PCT/KR/2019/009763, filed on Aug. 6, 2019, which claims priority to Korean Application No. 10-2018-0091142 filed Aug. 6, 2018. The aforementioned applications of which are incorporated herein by reference in their entireties.

TECHNICAL FIELD

(1) Embodiments of the present disclosure relate to a light emitting apparatus and a light radiator including the same.

BACKGROUND

(2) A light emitting diode refers to a semiconductor device that emits light through recombination of electrons and holes. The light emitting diode emits light in various wavelength bands, such as visible light and UV light, and may be used as a UV curing machine, a sterilizer, a light source, and the like. In particular, UV light emitting diodes are widely used in UV curing devices.

SUMMARY

(3) Embodiments of the present disclosure provide a light emitting apparatus emitting uniform light and a light radiator including the same.

(4) According to one or more embodiments of the present disclosure, a light emitting device includes a substrate having a luminous region and a non-luminous region, a plurality of light emitting structures disposed on the luminous region of the substrate, a window, a reflector, and an adhesive layer. The window has a dome shape and is disposed to cover the luminous region. The window is configured to control a traveling path of light emitted from the plurality of light emitting structures. The reflector is configured to support the window and reflect the light emitted from the plurality of light emitting structures. The reflector has an opening that exposes the plurality of light emitting structures mounted on the substrate. The adhesive layer is disposed between the window and the reflector. The window includes a base and a lens formed above one of surfaces of the base and an end portion of the base protrudes from a side surface of the lens. The window is configured to have a convex shape in the light traveling direction. A distance between two adjacent light emitting structures of the plurality of light emitting structures is 500 micrometers or less.

(5) In at least one variant, the non-luminous region is provided with conductive patterns electrically connected to the plurality of light emitting structures.

(6) In another variant, the plurality of light emitting structures emit light, via the dome shape of the window, at a beam angle of 90 degrees or more.

(7) In another variant, in a light profile of light emitted from the light emitting device, a difference between a valley value and a peak value is 10% or less.

(8) In another variant, the opening defines the luminous region and the lens has a bottom shape corresponding a shape of the opening.

(9) In another variant, a height of the window is 70% or less of a lower diameter thereof.

(10) In another variant, the distance between the two adjacent light emitting structures of the plurality of light emitting structures is 200 micrometers.

(11) In another variant, the luminous region includes a first pad disposed between the substrate and each of the light emitting structures, and a second pad disposed around the luminous region, wherein the plurality of light emitting diodes are connected to the second pad by electrical bonding.

(12) In another variant, the light emitting structures emit UV light.

(13) According to one or more embodiments of the present disclosure, a light emitting device includes a substrate having a first region and a second region, a plurality of light emitting structures disposed on the first region of the substrate, a window, and a reflector. The window has a dome shape and is disposed to cover the first region. The window is configured to control a traveling path of light emitted from the plurality of light emitting structures. The reflector is configured to support the window and reflect the light emitted from the plurality of light emitting structures. The reflector has an opening that exposes the plurality of light emitting structures mounted on the substrate. The window includes a base and a lens formed on one surface of surfaces of the base. The window is configured to have a convex shape in the light traveling direction. An end portion of the base protrudes from a side surface of the lens. In a profile of light emitted from the light emitting device,

a difference between a valley value and a peak value is 10% or less.

(14) In at least one variant, a distance between two adjacent light emitting structures is 500 micrometers or less.

(15) In another variant, the second region is provided with conductive patterns electrically connected to the light emitting structures.

(16) In another variant, the plurality of light emitting structures emit light, via the dome shape of the window, at a beam angle of 90 degrees or more.

(17) In another variant, the opening defines the first region and the lens portion has a bottom shape corresponding a shape of the opening.

(18) According to one or more embodiments of the present disclosure, a light emitting device includes a substrate having a luminous region and a non-luminous region, a light emitting unit disposed on the luminous region of the substrate, a window disposed to cover the luminous region, the window configured to control a traveling path of light emitted from the light emitting unit, a reflector configured to support the window and reflect the light emitted from the light emitting unit, and an adhesive layer. The reflector has an opening that exposes the light emitting unit mounted on the substrate. The adhesive layer is disposed between the substrate and the reflector. The window includes a base and a lens formed on one surface of surfaces of the base and is configured to have a convex shape in the light traveling direction. A height of the lens is 70% or less of a lower diameter thereof. In a light profile of light emitted from the light emitting device, a difference between a valley value and a peak value is 10% or less.

(19) In at least one variant, the non-luminous region is provided with conductive patterns electrically connected to the light emitting unit.

(20) In another variant, the light emitting device further includes a phosphor portion disposed in the window.

(21) In another variant, the reflector has a stepped portion on a top surface thereof.

(22) In another variant, the lens has a larger area than a size of the opening.

(23) In another variant, an inner wall of the opening has an inclined portion.

(24) In accordance with one embodiment of the present disclosure, a light emitting apparatus including a substrate, a plurality of light emitting diodes arranged in a matrix on the substrate, and a window disposed in a dome shape on the light emitting diodes and controlling a traveling path of light emitted from the light emitting diodes. A height of the window is 70% or less of a lower diameter thereof such that the light emitted from the light emitting diodes is condensed at a beam angle of 90 degrees or less.

(25) In at least one variant, the window may include a base and a lens portion protruding from one surface of the base and having a circular shape in plan view, and the lens portion may have different gradient variations depending upon an angle from an upper surface of the base with reference to the center of the circular shape on a cross-section of the lens portion perpendicular to the upper surface of the base and taken across the center of the circular shape on the base.

(26) In another variant, assuming that the lens portion sequentially has first to m .sup.th regions (m being an integer of 3 or more) according to an angle from the upper surface of the base with reference to the center of the circular shape, a gradient variation in an n .sup.th region ($1 < n < m$) may be greater than a gradient variation in an $(n-1)$.sup.th region and a gradient variation in an $(n+1)$.sup.th region.

(27) In yet another variant, on a cross-section of the lens portion taken across the center thereof, a curve constituting the lens portion may have a radius of curvature gradually decreasing and then increasing in a direction from the upper surface of the base towards a vertex of the lens portion.

(28) In further another variant, assuming that radii of curvature at three points sequentially disposed on a cross-section of the lens portion taken across the center thereof are referred to as first to third radii of curvature, respectively, the second radius of curvature may be less than the first and third radii of curvature.

- (29) In further another variant, the light emitting diodes may be disposed on a surface of the substrate corresponding to a region between points having the smallest radius of curvature at opposite sides on a cross-section of the lens portion taken across the center thereof.
- (30) In another variant, the light emitting diodes may emit light at a beam angle of 90 degrees or more.
- (31) In another variant, a distance between two adjacent light emitting diodes may be 500 micrometers or less.
- (32) In another variant, each of the light emitting diodes may be independently driven and may be a vertical type.
- (33) In another variant, in a profile of light emitted from the light emitting apparatus, a difference between a valley value and a peak value may be 10% or less.
- (34) In another variant, the light emitting apparatus may further include: a first pad disposed between the substrate and each of the light emitting diodes and a second pad disposed around the luminous region, wherein the light emitting diodes may be connected to the second pad by wire bonding.
- (35) In another variant, the light emitting diodes may emit UV light.
- (36) In some forms, the light emitting apparatus according to the embodiments of the present disclosure may be employed by a light radiator. The light radiator may include a plurality of light emitting apparatuses, wherein each of the light emitting apparatuses may include a substrate, a plurality of light emitting diodes arranged in a matrix on the substrate, and a window disposed in a dome shape on the light emitting diodes and controlling a traveling path of light emitted from the light emitting diodes. A height of the window is 70% or less of a lower diameter thereof such that the light emitted from the light emitting diodes is condensed at a beam angle of 90 degrees or less thereby.
- (37) Embodiments of the present disclosure provide a light emitting apparatus having high reliability. Embodiments of the present disclosure provide a light radiator employing the light emitting apparatus to emit uniform light.
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Description

DESCRIPTION OF DRAWINGS

- (1) FIG. 1 is a perspective view of a light emitting apparatus according to one embodiment of the present disclosure.
- (2) FIG. 2 is an exploded perspective view of the light emitting apparatus shown in FIG. 1.
- (3) FIG. 3 is a plan view of the light emitting apparatus shown in FIG. 1.
- (4) FIG. 4 is a cross-sectional view taken along line I-I' of FIG. 3.
- (5) FIG. 5 is a sectional view of a light emitting diode according to one embodiment of the present disclosure.
- (6) FIG. 6A is a perspective view of a window in the light emitting apparatus according to the embodiment of the present disclosure, and
- (7) FIG. 6B is a cross-sectional view of the window taken along line II-II' of FIG. 6A.
- (8) FIG. 6C is a cross-sectional view of the window taken along line II-II' of FIG. 6A.
- (9) FIG. 7A is a view of a conventional window of a conventional light emitting apparatus.
- (10) FIG. 7B is a view of a light profile of a conventional light emitting apparatus.
- (11) FIG. 8A is a view of a window according to one embodiment of the present disclosure
- (12) FIG. 8B is a light profile of a light emitting apparatus including the window of FIG. 8A.
- (13) FIG. 9A is a simulation profile of light emitted from a conventional light emitting apparatus including a window.
- (14) FIG. 9B is a simulation profile of light emitted from another conventional light emitting

apparatus.

(15) FIG. 9C is a simulation profile of light emitted from further another conventional light emitting apparatus.

(16) FIG. 10A is a simulation profiles of light emitted from a light emitting apparatus including a window according to one embodiment of the present disclosure.

(17) FIG. 10B is a simulation profile of light emitted from another light emitting apparatus.

(18) FIG. 10C is a simulation profile of light emitted from further another light emitting apparatus.

(19) FIG. 11A is a light profile of light emitting apparatus including a window having a similar shape to the window shown in FIG. 8A and a different height from the window shown in FIG. 8A.

(20) FIG. 11B is a light profile of light emitting apparatus including a window having a different height from the window shown in FIG. 11A.

(21) FIG. 11C is a light profile of light emitting apparatus including a window having a different height from the window shown in FIG. 11B.

(22) FIG. 12 is a perspective view of a light emitting apparatus according to one embodiment of the present disclosure.

DETAILED DESCRIPTION OF EMBODIMENTS

(23) It should be understood that various modifications, variations, and alterations can be made by those skilled in the art without departing from the spirit and scope of the present disclosure and specific embodiments will be illustrated in the drawings and described in detail. However, it should be understood that these embodiments are given by way of example only and are not intended to limit the present disclosure. Therefore, the scope of the present disclosure should be defined by the appended claims and equivalents thereto.

(24) Hereinafter, exemplary embodiments of the present disclosure will be described in detail.

(25) FIG. 1 is a perspective view of a light emitting apparatus according to one embodiment and FIG. 2 is an exploded perspective view of the light emitting apparatus shown in FIG. 1. FIG. 3 is a plan view of the light emitting apparatus shown in FIG. 1 and FIG. 4 is a cross-sectional view taken along line I-I' of FIG. 3.

(26) Referring to FIG. 1 to FIG. 4, the light emitting apparatus according to the embodiment of the present disclosure includes a substrate **110** defining an overall shape of the light emitting apparatus, a plurality of light emitting diodes **120** disposed on the substrate **110** and emitting light, and a window **190** disposed on the light emitting diodes **120** to control a traveling path of the light emitted from the light emitting diodes **120**.

(27) A pad portion is provided to the light emitting diodes **120** and electrically connected thereto. The pad portion may be connected to a terminal unit for electrical connection to external elements. The light emitting apparatus may be further provided with additional elements including the window allowing transmission of light emitted from the light emitting diodes **120** therethrough, an antistatic element **160**, and the like.

(28) The substrate **110** is configured to have at least one light emitting diode **120** mounted thereon.

(29) The substrate **110** may be provided with the at least one light emitting diode **120** and interconnects, for example, the pad portion, the terminal unit and/or connectors, to connect the at least one light emitting diode **120** to an external power source, external wires, and the like.

(30) The substrate **110** may have various shapes. By way of example, the substrate **110** has a substantially square shape in plan view and may be realized by a plate having a certain height. Alternatively, the substrate **110** may be provided in a rectangular shape in plan view and may have a pair of long sides and a pair of short sides. However, it should be understood that the shape or size of the substrate **110** is not limited thereto.

(31) At least part of the substrate **110** may be formed of a conductive material. The substrate **110** may be formed of, for example, a metal, which may include copper, iron, nickel, chromium, aluminum, silver, gold, titanium, and alloys thereof. However, it should be understood that the substrate **110** is not limited thereto and may be formed of a non-conductive material. For the

substrate **110** formed of the non-conductive material, a conductor may be disposed on an upper surface of the substrate **110**. The non-conductive material may include a ceramic material, a resin, glass, or a composite thereof (for example, a composite resin or a mixture of a composite resin and a conductive material).

(32) An insulating layer may be further disposed on the substrate **110** and first and second pads **111**, **130** described below may be provided on the insulating layer.

(33) The substrate **110** has a luminous region in which the light emitting diodes **120** are disposed to emit light and a non-luminous region excluding the luminous region. The luminous region and the non-luminous region may be determined according to the presence and arrangement of the light emitting diodes **120**, and the non-luminous region is provided with conductive patterns (for example, the pad portion, the terminal unit, and the like) electrically connected to the light emitting diodes **120** and with various elements (for example, the antistatic element **160**, a temperature measurement device **170**, and the like).

(34) The luminous region is provided with the plurality of light emitting diodes **120**, which will be described below.

(35) The substrate **110** may have a monolithic structure, without being limited thereto.

Alternatively, the substrate **110** may be realized by a combination of two sub-substrates **110**.

(36) The substrate **110** may be provided with a reflector **180** having a stepped portion **181** on which the window **190** is mounted. The window **190** may be mounted on the stepped portion **181** of the reflector **180**. The stepped portion **181** may have a depth substantially the same as a thickness of a base **191** of the window **190**, whereby an upper surface of the base **191** may be coplanar with an upper surface of the reflector **180** excluding the stepped portion **181**. Alternatively, the stepped portion **181** may have a greater thickness than the window **190**.

(37) The window **190** may be disposed in the luminous region of the substrate **110**. That is, the window **190** is disposed in a region in which the light emitting diodes **120** are arranged and through which light emitted from the light emitting diodes **120** travels. That is, the window **190** may have an area corresponding to the luminous region or a larger area than the luminous region. With this structure, the window **190** may cover the entirety of the luminous region.

(38) In this embodiment, the window **190** may have a lens shape that condenses light. The window **190** may include a plate-shaped base **191** and a lens portion **193** protruding upwards from the base **191**, as shown in FIGS. 1 and 2.

(39) In some forms, the window **190** is formed of a transparent insulating material to transmit light emitted from the light emitting diodes **120** and protects the light emitting diodes **120** while transmitting the light emitted from the light emitting diodes **120**. Further, the window **190** acts as an optical lens and changes a traveling path of light so as to have a predetermined beam angle upon transmission of light therethrough. For example, the lens portion **193** condenses light emitted from the light emitting diodes **120** so as to emit light at a beam angle of 90 degrees or less. According to the embodiment, even when the light emitting diodes **120** emit light at a beam angle of 90 degrees or more, the window **190** condenses the light emitted from the light emitting diodes **120** so as to emit light at a beam angle of 90 degrees or less. As a result, the emitted light has a relatively uniform profile.

(40) The window **190** may be formed of a material that is not deformed or discolored by light emitted from the light emitting diodes **120**. For example, when the light emitted from the light emitting diodes **120** is UV light, the window **190** may be formed of a material that is not deformed or discolored by UV light. The window **190** may be formed of various materials so long as the window can have the functions described above without being limited to a particular material. For example, the window **190** may be formed of quartz or a polymer organic material. Here, since polymer glass materials have different absorption/transmission wavelengths depending on the type of monomer, a molding method and molding conditions, the polymer glass material may be selected in consideration of the wavelength of light emitted from the light emitting diodes **120**. For

example, organic polymers, such as poly(methyl methacrylate) (PMMA), polyvinyl alcohol (PVA), polypropylene (PP), and low-density polyethylene (PE), hardly absorb UV light, whereas organic polymers such as polyesters can absorb UV light.

(41) In one embodiment, the base **191** (FIG. 2) may have a substantially square shape and the lens portion **193** may have a circular shape in plan view. However, these shapes are provided by way of example and the base **191** may have a different shape in plan view and, for example, may have the same shape as the lens portion **193**. In particular, the shape of the base **191** may be changed according to the shape of an opening **183** of the reflector **180**, which will be described below. When the opening **183** has a circular shape, the base **191** may also have a circular shape similar to the lens portion **193**.

(42) The shape of the window **190** will be further described below.

(43) The reflector **180** supports the window **190** while reflecting the light emitted from the light emitting diodes **120**. In particular, a sidewall of the reflector **180** facing the light emitting diodes **120** reflects the light emitted from the light emitting diodes **120**.

(44) The reflector **180** is coupled to an upper portion of the substrate **110**. The reflector **180** may be formed with the opening **183** that exposes the light emitting diodes **120** mounted on the substrate **110**. The opening **183** may have a rectangular shape in plan view, but it is not limited thereto. Alternatively, the opening **183** may have a circular shape or other polygonal shapes. Such a shape may be modified in various ways depending upon a mounting structure of the light emitting diodes **120** or a desired shape of light emitted from the light emitting apparatus.

(45) The window **190** may be mounted on a portion of the reflector **180** in which the opening **183** is formed. To this end, a stepped portion, for example, a mounting groove, may be formed on an inner surface of the opening **183**.

(46) Further, the reflector **180** may be provided with a fastening portion **150** for fastening with the substrate **110**, as shown in FIGS. 1 and 3. The fastening portion **150** may be realized in various forms, for example, in the form of at least one fastening hole **151**, which is formed through upper and lower surfaces of the reflector, and a screw **153** inserted into the fastening hole **151**, as shown in FIG. 2. The fastening hole **151** may be provided to each of opposite sides of the reflector **180**. Although not shown, the substrate **110** may be provided with substrate holes corresponding to the fastening holes **151**, in which the substrate holes may have substantially the same diameter as that of the fastening holes. The reflector **180** may be fastened to the substrate **110** using fastening members, such as screws **153**, with the fastening holes **151** and the substrate holes disposed at the same locations.

(47) In this embodiment, the reflector **180** serves to guide light emitted from the light emitting diodes **120** disposed inside the opening **183** to be discharged through an upper portion thereof while protecting the light emitting diodes **120** disposed inside the opening **183**.

(48) Further, the reflector **180** may include a metal such that heat generated from the light emitting diodes **120** can be transferred to the reflector **180** through the substrate **110** so as to be dissipated through the reflector **180**.

(49) A coating may be formed on an outer surface of the reflector **180** by an anodizing method, whereby the outer surface of the reflector **180** may be black.

(50) The window **190** is inserted into the stepped portion **181** formed on the reflector **180** to be coupled to the reflector **180**. Accordingly, the window **190** may have a larger area than the opening. In addition, the window **190** may be formed of a material, such as glass and the like, and may have one or more types of phosphors dispersed therein.

(51) The reflector **180** may be bonded to the substrate **110** via a bonding layer **107** interposed therebetween, as shown in FIG. 4. The bonding layer **107** may be formed of any material capable of bonding the reflector **180** to the substrate **110** without being limited to a particular material.

(52) The bonding layer **107** may be formed of an organic polymer-containing organic adhesive or a metal-containing solder. When the bonding layer **107** is formed of the organic adhesive, the

bonding layer **107** may be interposed between the reflector **180** and the substrate **110** to bond the reflector **180** to the substrate **110**. When the bonding layer **107** is formed of the metal-containing solder, the bonding layer **107** may be subjected to surface treatment such that opposite surfaces of the reflector **180** and the substrate **110** facing each other can be soldered. For example, a separate soldering pad may be further formed through surface treatment to facilitate soldering in a region of the substrate **110** on which the reflector **180** will be disposed.

(53) In this embodiment, the reflector **180** serves to guide light emitted from the light emitting diodes **120** disposed inside the opening **181** to be discharged through the upper portion thereof while protecting the light emitting diodes **120** disposed inside the opening **181**. Further, the reflector **180** may include a metal such that heat generated from the light emitting diodes **120** can be transferred to the reflector **180** through the substrate **110** so as to be dissipated through the reflector **180**.

(54) In this embodiment, although an inner wall of the reflector **180** defining the opening **183** corresponding to the luminous region is illustrated as being perpendicular to an upper surface of the substrate **110**, it should be understood that other implementations are possible and the reflector may have other shapes so as to improve luminous efficacy. For example, the inner wall of the reflector **180** defining the opening may be slanted with respect to the upper surface of the substrate **110**.

(55) The reflector **180** may be formed with a protective groove recessed from one side thereof towards the opening **183**. That is, the protective groove may be formed between opposite protruding ends of an outer side surface of the reflector **180**. When the reflector **180** is disposed on the substrate **110**, the elements (for example, the antistatic element **160**, the temperature measurement device **170**, and the like) mounted on the substrate **110** are disposed in the protective groove of the reflector **180** such that the reflector **180** surrounds at least part of the elements to protect the surrounded elements from the outside.

(56) In some forms, the light emitting diodes **120** are provided in plural and are disposed in the luminous region of the substrate **110**.

(57) In the embodiment, the light emitting diodes **120** are arranged in a matrix. The matrix may have any shape as long as the light emitting diodes are arranged in rows and columns as a whole, and the rows and the columns are necessarily be provided in the form of straight columns.

(58) In some forms, the light emitting diodes **120** disposed between two adjacent rows and between two adjacent columns are separated by a predetermined distance or less from each other. For example, a distance L between two adjacent light emitting diodes **120** may be 500 micrometers or less. If the distance L between two adjacent light emitting diodes **120** exceeds 500 micrometers, non-uniform illumination occurs due to difference in luminous quantity between a region above the light emitting diodes **120** and a region above a gap between the light emitting diodes **120**. In this case, it is difficult to overcome non-uniformity even when the window **190** condenses the light emitted from the light emitting diodes.

(59) In one embodiment, the light emitting diodes **120** may be connected to one power source so as to be operated at the same time or may be connected to different power sources so as to be independently operated.

(60) In one embodiment, the light emitting diodes **120** may be vertical type light emitting diodes. FIG. 5 is a sectional view of the light emitting diode **120** according to one embodiment of the present disclosure.

(61) Referring to FIG. 5, the light emitting diode **120** includes a light emitting structure, which includes a first semiconductor layer **123**, an active layer **125**, and a second semiconductor layer **127**, and an anode **121** and a cathode **129** connected to the light emitting structure.

(62) The first semiconductor layer **123** is doped with a first conductivity type dopant. The first conductivity type dopant may be a p-type dopant. For instance, the first conductivity type dopant may include Mg, Zn, Ca, Sr, Ba, and the like.

(63) In other forms, the first semiconductor layer **123** may include a nitride semiconductor

material. For example, the first semiconductor layer **123** may be formed of a semiconductor material having a composition represented by $\text{In}_{0.5x}\text{Al}_{0.5y}\text{Ga}_{1-x-y}\text{N}$ ($0 \leq x \leq 1$, $0 \leq y \leq 1$, $0 \leq x+y \leq 1$). In some embodiments, the semiconductor material having this composition may include GaN, AlN, AlGaIn, InGaIn, InN, InAlGaIn, AlInN, and the like. The first semiconductor layer **123** may be formed by growing the semiconductor material so as to contain the p-type dopant, such as Mg, Zn, Ca, Sr, Ba, and the like.

(64) The active layer **125** is formed on the first semiconductor layer **123** and acts as a light emitting layer. The active layer **125** is a layer in which electrons (holes) injected through the first semiconductor layer **123** recombine with holes (electrons) injected through the second semiconductor layer **127** to emit light based on a band gap between energy bands of materials forming the active layer **125**. The active layer **125** may emit light such as UV light, visible light, and IR light.

(65) The active layer **125** may be realized by a compound semiconductor. By way of example, the active layer **125** may be realized by at least one selected from among Group III-V or II-VI compound semiconductors. The active layer **125** may employ a quantum well structure. In some forms, the active layer **125** may have a multi-quantum well structure in which quantum well layers and barrier layers are alternately stacked one above another. However, the active layer **125** is not limited thereto and may have a quantum wire structure, a quantum dot structure, or the like.

(66) The second semiconductor layer **127** is formed on the active layer **125**. The second semiconductor layer **127** is a semiconductor layer doped with a second conductivity type dopant having an opposite polarity to the first conductivity type dopant. The second conductivity type dopant may be an n-type dopant and may include, for example, Si, Ge, Se, Te, O, C, and the like.

(67) In one embodiment, the second semiconductor layer **127** may include a nitride semiconductor material. For example, the second semiconductor layer **127** may be formed of a semiconductor material having a composition represented by $\text{In}_{0.5x}\text{Al}_{0.5y}\text{Ga}_{1-x-y}\text{N}$ ($0 \leq x \leq 1$, $0 \leq y \leq 1$, $0 \leq x+y \leq 1$). In some embodiments, the semiconductor material having this composition may include GaN, AlN, AlGaIn, InGaIn, InN, InAlGaIn, AlInN, and the like. The second semiconductor layer **127** may be formed by growing the semiconductor material so as to contain the n-type dopant, such as Si, Ge, Se, Te, O, C, and the like.

(68) The anode **121** may be disposed on a lower surface of the first semiconductor layer **123** to contact the first semiconductor layer **123**. In one embodiment, the anode **121** may be used as the substrate **110** providing a stack structure. The cathode **129** may be disposed on an upper surface of the second semiconductor layer **127** to contact the second semiconductor layer **127**.

(69) In one embodiment, the anode **121** and the cathode **129** may be formed of various metals, for example, Al, Ti, Cr, Ni, Au, Ag, Ti, Sn, Ni, Cr, W, and Cu, or alloys thereof. The anode **121** and the cathode **129** may be formed in a single layer or multiple layers.

(70) In one embodiment, the light emitting diode **120** may emit light in various wavelength bands depending upon the material and stack structure thereof. The light emitted from the light emitting diode **120** is ultraviolet (UV) light, visible light, or infrared (IR) light, without being limited thereto. The light emitting diodes **120** may emit light having various wavelengths depending upon the material and composition of the light emitting layer. In this embodiment, the light emitting diode **120** may emit light in the UV wavelength band.

(71) Although the light emitting diode **120** according to this embodiment is a vertical type, it should be understood that the light emitting diode **120** is not limited thereto and may be implemented with other types without departing from the concept of the present disclosure.

(72) Referring again to FIG. 1 to FIG. 4, the luminous region and the non-luminous region adjacent to the luminous region are provided with the pad portion to supply power to the light emitting diode **120**.

(73) The pad portion includes first pads **111** connected to the anodes **121** of the light emitting diodes **120** and second pads **130** (shown in FIG. 4) connected to the cathodes **129** of the light

emitting diodes **120**.

(74) The first pads **111** may be disposed in the luminous region and correspond to the light emitting diodes **120**, respectively, and may be placed at the same locations of the light emitting diodes **120**. That is, the number of first pads **111** may be the same as the number of light emitting diodes **120** mounted on the substrate **110**.

(75) Each of the first pads **111** is provided as a site for mounting the light emitting diode **120** and may have substantially the same shape as the light emitting diode **120** in plan view. In the embodiment, the first pad **111** may be integrally formed with the substrate **110**. In this embodiment, nine light emitting diodes **120** may be disposed in the form of a 3×3 matrix and nine first pads **111** may also be provided corresponding to the light emitting diodes **120**. The plurality of first pads **111** may be regularly arranged in rows and columns corresponding to arrangement of the light emitting diodes **120**. However, it should be understood that the number of light emitting diodes **120** is not limited thereto.

(76) The light emitting diode **120** is mounted on the first pad **111**. A conductive bonding member may be provided to each of the first pad **111** and the anode of the light emitting diode **120**. As the conductive bonding member, conductive pastes formed of a conductive material, for example, silver (Ag) pastes, may be used. Accordingly, the first pad **111** and the anode **121** of the light emitting diode **120** are electrically connected to each other therethrough.

(77) The second pad **130** may be disposed in the luminous region and along a region adjacent to the luminous region, specifically along the circumference of the luminous region, as shown in FIG. 4. The second pad **130** is disposed at a location separated from the light emitting diode **120**.

(78) The second pad **130** may be disposed outside the plurality of first pads **111**. The second pad **130** may be provided in plural. For example, four second pads **130** are disposed outside the plurality of first pads **111** to surround the first pads **111**.

(79) The second pads **130** may be connected to the cathodes **129** of the light emitting diodes **120** by wire bonding. In other words, an upper surface of each of the second pads **130** is connected to the cathode of the light emitting diode **120** through a wire W, as shown in FIG. 4. Here, although the second pads **130** are connected to the cathodes of the light emitting diodes **120** through two wires W, it should be understood that this structure is provided for convenience of description and a single wire or a different number of wires W may be used.

(80) In embodiments of the present disclosure, the number of light emitting diodes **120** and the number of first and second pads **111**, **130** are not limited thereto and may be determined in various ways.

(81) The non-luminous region is provided with the terminal unit electrically connected to the pad portion. The terminal unit is disposed in a region on the substrate **110** in which the reflector **180** and the window **190** are not disposed.

(82) The terminal unit is provided to one side of the substrate **110** to facilitate connection to an external power source and includes a first terminal **141** and a second terminal **143**, as shown in FIG. 3. However, it should be understood that the location of the terminal unit is not limited thereto and may be changed.

(83) The first terminal **141** is electrically connected to the first pad **111**. In the embodiment, the first terminal **141** may be integrally formed with the substrate **110**. When the substrate **110** is formed of a metal, the first pad **111** is electrically connected to the first terminal **141**. The second terminal **143** may be placed near the first terminal **141** and may be electrically connected to the second pad **130**. The second terminal **143** may be electrically connected to the second pad **130** through a conductive wire on the substrate **110**, as in a wire formed on a printed circuit board.

(84) Each of the first terminal **141** and the second terminal **143** may be provided with a separate compression terminal so as to be electrically connected to an external power source connector.

(85) In this embodiment, the first terminal **141** and the second terminal **143** are formed of a conductive material. For example, the first and second terminals **141**, **143** may be formed of a

metal. The metal may include copper, iron, nickel, chromium, aluminum, silver, gold, titanium, palladium, and alloys thereof. In addition, each of the first and second terminals **141**, **143** may be a single layer film or a multilayer film. For example, the first and second terminals **141** and **143** may be formed of Ni/Au, Ni/Ag and Ni/Pd/Au.

(86) The antistatic element **160** may be further provided to the terminal unit. The antistatic element **160** may be electrically connected to the first and second terminals **141**, **143** and may be realized by a Zener diode or a transient voltage suppressor (TVS). The antistatic element **160** prevents damage to the light emitting apparatus due to discharge or surge of static electricity.

(87) In addition to the antistatic element **160**, the temperature measurement device **170** may be further disposed on the substrate **110**. The temperature measurement device **170** may serve to measure the temperature of the light emitting apparatus due to operation of the light emitting diodes **120**. According to one embodiment, the temperature measurement device **170** may measure resistance to determine the temperature of the light emitting apparatus.

(88) In addition, a terminal may be formed on the substrate **110** to be connected to an element connector DC for supplying power to the antistatic element **160** and/or the temperature measurement device **170**, as shown in FIG. 3.

(89) Next, the light emitting apparatus according to the embodiment of the present disclosure will be described in detail with reference to FIGS. 1-4.

(90) The light emitting apparatus includes the substrate **110**, the first pads **111**, the second pads **130**, the light emitting diodes **120**, the reflector **180**, and the window **190**, which are mounted on the substrate **110**.

(91) The substrate **110** may have a plate shape and a substantially flat upper surface. Here, in the luminous region on which the light emitting diodes **120** are mounted, the first pads **111** may be integrally formed with the substrate **110**. For example, the first pads **111** may be realized by protrusions protruding from the upper surface of the substrate **110**. When the substrate **110** is used as the first pads **111**, an external power source may be electrically connected to the substrate **110** in order to supply electric power to the first pads **111**. In addition, with the structure where the first pads **111** are integrally formed with the substrate **110**, heat generated from the light emitting diodes **120** mounted on the first pads **111** can be directly transferred to the substrate **110** through the first pads **111**, thereby enabling rapid dissipation of heat. Further, although not shown in the drawings, the first terminal **141**, the first terminal **141** (**161**) for the antistatic element **160**, and the temperature measurement device **170** may also be realized by protrusions protruding from the upper surface of the substrate **110** in the luminous region thereof.

(92) A first insulating layer **103** is formed on the substrate **110**. The first insulating layer **103** serves to insulate the first pads **111** from the second pads **130**. The first insulating layer **103** covers at least part of the upper surface of the substrate **110**. In this embodiment, as shown in FIG. 4, the first insulating layer **103** is formed in most regions of the substrate **110** excluding regions of the substrate **110** in which the protrusions are formed.

(93) In some forms, the first insulating layer **103** may be formed of various insulating materials having adhesive strength, for example, a polymer resin. The material of the first insulating layer **103** is not particularly limited.

(94) The second pads **130** are disposed on the first insulating layer **103** and are disposed adjacent to the first pads **111** so as to be spaced apart therefrom. As shown in the drawings, the second pads **130** may be disposed on opposite sides of the luminous region, respectively, and may be electrically connected to the light emitting diodes **120** by wires W. Here, the second pads **130** may have the same height as the first pads **111**. The second pads **130** are electrically insulated from the first pads **111** by the first insulating layer **103**.

(95) In this embodiment, the first pads **111** and the second pads **130** are formed of a conductive material. For example, the first pads **111** and the second pads **130** may be formed of a metal, which may include copper, iron, nickel, chromium, aluminum, silver, gold, titanium, palladium, and

alloys thereof. In one embodiment, one of the first pad **111** and the second pad **130**, particularly, the second pad **130**, may be a single layer pad or a multilayer pad. For example, the first pads **111** and the second pads **130** may be formed of Ni/Au, Ni/Ag and Ni/Pd/Au.

(96) A second insulating layer **105** may be formed in a region of the substrate **110**, on which the second pad **130** is disposed.

(97) The second insulating layer **105** may be formed of various insulating materials, for example, a photosensitive resist (PSR). However, it should be understood that the material of the second insulating layer **105** is not limited thereto.

(98) The second insulating layer **105** covers most of the upper surface of the substrate **110** except for some regions of the first pads **111** and the second pads **130** adjacent to the luminous region. The light emitting diodes **120** are disposed on the first pads **111** to which the second insulating layer **105** is not provided, and the wire W is connected to the second pads **130** to which the second insulating layer **105** is not provided.

(99) The second insulating layer **105** is not formed on at least part of the first and second terminals **141**, **143** and the substrate holes. In addition, the second insulating layer **105** is not formed on the first and second terminals **141**, **143** for the antistatic element **160**, on which the antistatic element **160** is mounted, and is not formed on the terminal for the temperature measurement device **170**. Upper surfaces of the protrusions of the substrate **110** or upper surfaces of the second pads **130** may be exposed on a portion of the substrate **110** to which the second insulating layer **105** is not provided, as shown in FIG. 4.

(100) The reflector **180** is disposed on the second insulating layer **105**. The reflector **180** is disposed on the substrate **110** and may be bonded to the substrate **110** by the bonding layer **107**. The bonding layer **107** is disposed between the reflector **180** and the substrate **110** and may be applied to regions of the substrate **110** excluding the substrate holes.

(101) As such, the reflector **180** may be coupled to the substrate **110** by the bonding layer **107** and may be coupled again thereto by fastening members, as shown in FIGS. 1-4. Here, when the reflector **180** is normally placed on the substrate **110**, the fastening hole **151** of the reflector **180** extends to the corresponding substrate hole of the substrate **110** to form a single hole and a fastening member, such as a screw **153**, recouples the reflector **180** to the substrate **110** through the fastening hole **151** and the substrate hole. As such, by recoupling the reflector **180** to the substrate **110** using the fastening member, it is possible to prevent the reflector **180** from being separated from the substrate **110** even when adhesive strength of the bonding layer **107** is reduced due to heat generated from the light emitting diodes **120**. Here, the bonding layer **107** may contain a material capable of transferring heat from the substrate **110** to the reflector **180**.

(102) The window **190** is disposed on the stepped portion **181** of the reflector **180** and may also be disposed on the bonding layer, although not shown in the drawings. The window **190** is disposed above the light emitting diodes **120** and overlaps the light emitting diodes **120** in plan view. The window **190** may have various shapes and may change the traveling path of light emitted from the light emitting diodes **120**. In one embodiment, the window **190** may narrow the beam angle of light emitted from the light emitting diodes **120** to a predetermined angle or less.

(103) FIG. 6A is a perspective view of the window in the light emitting apparatus according to the embodiment of the present disclosure, and FIG. 6B and FIG. 6C are cross-sectional views of the window taken along line II-II' of FIG. 6A.

(104) Referring to FIG. 6A to FIG. 6C, a window **190** according to one embodiment of the present disclosure includes a base **191** having a plate shape and a lens portion **193** protruding from one surface of the base **191**.

(105) The base **191** may include a plate having a shape corresponding to the opening of the reflector **180** (see FIG. 1 through FIG. 4), for example, a rectangular shape. The base **191** has a size corresponding to the size of the opening so as to be seated on the stepped portion in the opening of the reflector **180**. However, it should be understood that the shape or size of the base **191** is not

limited thereto and may be changed according to the shape of the opening and/or the stepped portion.

(106) The lens portion **193** is formed on one surface of the base **191** and protrudes from the one surface of the base **191**. Here, the lens portion **193** may be convex in a light traveling direction. The lens portion **193** serves to condense light emitted from light emitting diodes **120** and has a convex lens shape.

(107) In one embodiment, the base **191** may be integrally formed with the lens portion **193**, but is not limited thereto. Alternatively, the base **191** and the lens portion **193** may be separately formed and coupled to each other.

(108) The lens portion **193** may include a bottom contacting the base **191** and a curved portion **193** corresponding to a portion protruding from the base **191**, and has a substantially hemispherical shape. The lens portion **193** may have a circular shape in plan view. That is, the bottom of the lens portion has a circular shape. However, it should be understood that the bottom of the lens portion is not limited thereto and may have an elliptical shape or other shapes.

(109) In this embodiment, although the lens portion **193** has a substantially hemispherical shape, the lens portion **193** does not have an accurate hemispherical shape and has a smaller height than the hemispherical shape. In other words, a cross-section of the lens portion **193** taken along the center of the circular shape is not a semi-circular cross-section. The lens portion **193** has a smaller height than a diameter D of a circle constituting the bottom of the base. In particular, the height of the lens portion **193** may be 70% or less of the diameter D of the bottom.

(110) Here, the height H of the lens portion **193** means the shortest distance from the bottom to the vertex of the lens portion **193**, that is, a distance from the bottom to the vertex of the lens portion **193** in a direction perpendicular to the base **191**. When the bottom has a circular shape, the height H of the lens portion **193** refers to a distance from an upper surface of the base **191** to a point the lens portion **193** corresponding to the center of a circular shape thereof.

(111) In one embodiment, in a cross-section of the lens portion **193** perpendicular to the upper surface of the base **191** and taken along the center of the circular shape on the base **191**, the lens portion **193** may have different gradient variations depending upon an angle from the upper surface of the base with reference to the center of the circular shape. In particular, the lens portion **193** is configured to have a gradient variation that gradually increases and then decreases.

(112) Accordingly, in the window **190** according to the embodiment, when the lens portion **193** is divided into a plurality of regions according to an angle from the upper surface of the base **191** with reference to the center of the circular shape, a gradient variation in each region is different from that of another region adjacent thereto. For example, assuming that the lens portion **193** sequentially has first to m.sup.th regions (m being an integer of 3 or more) according to the angle from the upper surface of the base with reference to the center of the circular shape, a gradient variation in an n.sup.th region ($1 < n < m$) may be greater than a gradient variation in an (n-1).sup.th region and a gradient variation in an (n+1).sup.th region.

(113) In FIG. 6B, for convenience of description, the lens portion **193** is divided into 6 sectors according to an angle from the upper surface of the base **191** with reference to the center of the circular shape and angles changed between lines connecting both sides of an arc of each sector are denoted by θ_1 , θ_2 , θ_3 , θ_4 , and θ_5 , respectively. Referring to FIG. 6B, the variations in angle, that is, the gradient variations, may have different values in regions adjacent to one another and may have a shape that gradually increases and then decreases again. In particular, the gradient variations are gradually changed such that the variation of the angle in the fifth region is the largest and the variation of the angle in the sixth region tends to decrease again.

(114) In addition, the curved portion has different radii of curvature depending on the location thereof. For example, in a cross-section of the lens portion **193** taken across the center of the lens portion **193**, the curved portion may have different radii of curvature depending on the height of the lens portion **193** from the bottom thereof.

(115) According to one embodiment, in the cross-section taken across the center of the lens portion **193**, the radius of curvature of a curve constituting the lens portion **193** does not monotonously increase or decrease from the upper surface of the base **191** to the vertex of the lens portion **193**. According to the embodiment, in the cross-section taken across the center of the lens portion **193**, the radius of curvature of the curve constituting the lens portion **193** may gradually increase and then decrease from the upper surface of the base **191** to the vertex of the lens portion **193**.

Accordingly, in the cross-section taken across the center of the lens portion **193**, a portion having the smallest radius of curvature may be placed between the lowermost portion of the lens portion **193** and the uppermost portion of the lens portion **193** (that is, the vertex thereof).

(116) By way of example, assuming that radii of curvature of three points P1, P2, P3 arranged in sequence on the cross-section taken across the center of the lens portion **193** is first to third radii of curvature, a point having the smallest radius of curvature may be placed between the first point and the third point. Assuming that the point having the smallest radius of curvature is the second point P2 on the cross-section taken across the center of the lens portion **193**, the second radius of curvature is smaller than the first and third radii of curvature. Here, the light emitting diodes are disposed in a region on the surface of the substrate corresponding to a region between the points having the smallest radius of curvature at both sides (indicated by D' in the drawing) on the cross-section taken across the center of the lens portion **193**, that is, between the second points P2 at both sides. In the lens portion **193**, since the radius of curvature gradually increases from the second point P2 having the smallest radius of curvature to the third point P3, condensation of light emitted from the light emitting diodes and traveling upwards from the bottom is easily achieved.

(117) In one embodiment, when the light emitting diode is provided in plural, all of the light emitting diodes may be disposed in the region D' between the points having the smallest radius of curvature at both sides on the cross-section taken across the center of the lens portion **193**.

Accordingly, the light emitting diodes disposed in the outermost regions may also be disposed between the points D' having the smallest radius of curvature at both sides on the cross-section taken across the center of the lens portion **193**.

(118) For example, when the light emitting diodes are arranged in a $p \times q$ matrix, all of the light emitting diodes including light emitting diodes located in the outermost regions of the $p \times q$ matrix (that is, 1 row 1 column, p row 1 column, 1 row q column, p row p column) may be disposed between the points D' having the smallest radius of curvature at both sides on the cross-section taken across the center of the lens portion **193**.

(119) When the light emitting diode is provided in plural, the quantity of light is different between the top of each of the light emitting diodes **120** and a gap between adjacent light emitting diodes **120**. As a result, depending on arrangement of the light emitting diodes **120**, portions having larger and smaller quantities of light intensity than adjacent portions may appear alternately, whereby peaks and valleys may appear clearly in a light profile. In this case, it is difficult to achieve uniform irradiation with light due to difference in quantity of light depending on the location. However, when light is condensed through the window **190**, the valley is significantly reduced in the light profile and the difference in quantity of light according to the location within a beam angle of 90 degrees is significantly reduced. Accordingly, uniform light may be implemented as a whole without a sudden change in quantity of light.

(120) In the following description, light profiles of light emitting apparatuses including a conventional window and the window having the above structure will be compared.

(121) FIG. 7A and FIG. 7B are a view of a conventional window and a light profile of a conventional light emitting apparatus including the same, and FIG. 8A and FIG. 8B are a view of a window according to one embodiment of the present disclosure and a light profile of a light emitting apparatus including the same, respectively. Here, the conventional light emitting apparatus and the light emitting apparatus according to the embodiment are manufactured under the same conditions except for the window. Nine (9) light emitting diodes were arranged in a 3×3 matrix and

a distance between adjacent light emitting diodes was 200 micrometers. The window shown in FIG. 7A and FIG. 7B had a diameter-to-height ratio of 76% and the window shown in FIG. 8A and FIG. 8B had a diameter-to-height ratio of 55%.

(122) First, referring to FIG. 7A and FIG. 7B, when the lens portion is divided into 6 sectors according to an angle from the upper surface of the base with reference to the center of the circular shape and gradient variations between lines connecting both sides of an arc of each sector are denoted by first to fifth variations, respectively, the first to fifth variations have different values in adjacent regions and gradually increase.

(123) In a light profile of the light emitting apparatus employing such a window, although the beam angle is within 90 degrees, there is a large difference in quantity of light according to the angle. As a result, the peaks and the valleys are clearly shown in the light profile and, although there are differences depending on the angle, there is a section in which the quantity of light corresponding to the valley is only about 50% of the quantity of light at the peak. These peaks and valleys are caused by the distance between adjacent light emitting diodes and, in this case, it is difficult to achieve uniform irradiation with light due to difference in quantity of light depending on the location, as shown in FIG. 7B.

(124) Next, referring to FIG. 8A and FIG. 8B, when the lens portion is divided into 6 sectors according to an angle from the upper surface of the base with reference to the center of the circular shape and gradient variations between lines connecting both sides of an arc of each sector are denoted by first to fifth variations, respectively, the first to fifth variations have different values in adjacent regions and have a shape in which the variations gradually increase and then decrease.

(125) In a light profile of the light emitting apparatus employing such a window, the beam angle is within 90 degrees and the quantity of light according to the angle also shows a constant tendency and a uniform value as a whole. That is, in the light profile, there is only a large peak as a whole and a valley is not clearly shown. Even when there is a peak, the difference between the valley and the peak is less than 10%, as shown in FIG. 8B.

(126) As a result, it can be seen that, even with the same light emitting diodes as the light emitting apparatus shown in FIG. 7A and FIG. 7B, the light emitting apparatus shown in FIG. 8A and FIG. 8B exhibits improvement in uniformity and concentration of light and uniform irradiation with light is facilitated due to difference in quantity of light depending on the location.

(127) FIG. 9A to FIG. 9C are simulation profiles of light emitted from a conventional light emitting apparatus including a window and FIG. 10A to FIG. 10C are simulation profiles of light emitted from a light emitting apparatus including a window according to one embodiment of the present disclosure. Here, the conventional light emitting apparatus and the light emitting apparatus according to the embodiment are manufactured under the same conditions except for the window. The conventional light emitting apparatus employed the window shown in FIG. 7A and the light emitting apparatus according to the embodiment employed the window shown in FIG. 8A.

(128) In FIG. 9A and FIG. 10A, nine (9) light emitting diodes were arranged in a 3×3 matrix and a distance between adjacent light emitting diodes was 200 micrometers. In FIG. 9B and FIG. 10B, nine (9) light emitting diodes were arranged in a 3×3 matrix and had a larger area than the light emitting diodes shown in FIG. 9A and FIG. 10A. Here, a distance between adjacent light emitting diodes was 200 micrometers. In FIG. 9C and FIG. 10C, sixteen (16) light emitting diodes were arranged in a 4×4 matrix and had a larger area than the light emitting diodes shown in FIG. 9A and FIG. 10A. Here, a distance between adjacent light emitting diodes was 200 micrometers.

(129) Referring to FIG. 9A to FIG. 9C, although the beam angle is within 90 degrees, there is a large difference in quantity of light according to the angle. As a result, the peaks and the valleys are clearly shown in the light profile. It is difficult to achieve uniform irradiation with light due to difference in quantity of light depending on the location.

(130) Referring to FIG. 10A through FIG. 10C, the beam angle is within 90 degrees and the quantity of light according to the angle also shows a constant tendency and a uniform value as a

whole. That is, in the light profile, there is only a large peak as a whole and a valley is not clearly shown.

(131) As such, it can be seen that the light emitting apparatus according to the teachings of the present disclosure achieves improvement in uniformity and concentration of light.

(132) FIG. 11A to FIG. 11C are light profiles of light emitting apparatuses each including a window according to the teachings of the present disclosure, in which the window has a similar shape to the window shown in FIG. 8A and a different height from the window shown in FIG. 8A. Here, the light emitting apparatuses according to the embodiments were manufactured under the same conditions as ones of FIG. 8A except for the window. FIG. 11A shows a window includes a base having a diameter of 10 mm and a height of 4.5 mm, FIG. 11B shows a window includes a base having a diameter of 10 mm and a height of 5.5 mm, and FIG. 11C shows a window includes a base having a diameter of 10 mm and a height of 6.5 mm.

(133) Referring to FIG. 11A to FIG. 11C, for all of the light emitting apparatuses, the beam angle is within 90 degrees and the quantity of light according to the angle also shows a constant tendency and a uniform value as a whole. That is, in the light profile, there is only a large peak as a whole and a valley is not clearly shown. Here, it can be seen that even an unclear portion that is determined to be a valley had little difference in intensity from all peaks.

(134) As described above, in the light profile, the valley is significantly reduced and the difference in quantity of light according to the location within a beam angle of 90 degrees is also significantly reduced. Accordingly, it is possible to realize uniform light without rapid variation in intensity of light. As a result, the light emitting apparatus according to the embodiment of the present disclosure can provide light having high directionality while minimizing deviation in intensity of light in a predetermined region.

(135) The light emitting apparatus according to one or more embodiments of the present disclosure may be realized in various sizes and shapes and may be provided singularly or in plural to other devices. FIG. 12 is a perspective view of a light emitting apparatus according to one embodiment of the present disclosure. The following description will focus on different features of the embodiment from the above embodiments in order to avoid repetition of description and components having substantially the same functions are denoted by the same or like reference numerals.

(136) Referring to FIG. 12, the light emitting apparatus according to the embodiment has a generally similar shape to the light emitting apparatus shown in FIG. 1 except for a substrate 110, reflectors, and the like. The substrate 110 may have a rectangular shape having long sides and short sides and the reflectors may be disposed at opposite sides of the light emitting diode to be spaced apart from each other. A first terminal 141 and a second terminal 143 are provided to opposite ends of the substrate 110 at which the reflector is not formed.

(137) As such, the light emitting apparatuses having various shapes may be arranged in various ways to achieve efficient illumination of a target with light.

(138) The light emitting apparatus according to the embodiments may be employed in various devices. For example, the light emitting apparatus according to the embodiments may be used for a light radiator. The light radiator emits light to various materials for various purposes. In one embodiment, the light radiator may be used to cure polymeric materials. The light radiator may include at least one light emitting apparatus described above.

(139) Although some embodiments have been described herein, it should be understood by those skilled in the art that these embodiments are given by way of example only, and that various modifications, variations, and alterations can be made without departing from the spirit and scope of the present disclosure.

(140) Therefore, it should be understood that the scope of the present disclosure should be defined by the appended claims and equivalents thereto.

Claims

1. A light emitting device comprising: a substrate including a luminous region and a non-luminous region; and a light emitter disposed on the luminous region of the substrate and configured to emit light with a first range of a beam angle, the light emitter including a first electrode and a second electrode; a window disposed on the substrate and configured to cover the luminous region, the window further configured to control a traveling path of light emitted from the light emitter to have a second range of the beam angle that is different from the first range of the beam angle; a first pad disposed on the substrate and electrically coupled to the first electrode of the light emitter; a second pad disposed on the substrate and electrically coupled to the second electrode of the light emitter; a first insulator disposed on the luminous region of the substrate and configured to insulate the first pad from the second pad, the first insulator covering at least a region of an upper surface of the substrate; and a second insulator disposed on the non-luminous region of the substrate and configured to cover a region of the upper surface of the substrate except for the luminous region, wherein the first insulator is disposed between the first pad and the second pad, wherein the second insulator is configured to cover a region of the second pad and wherein the second insulator, the region of the second pad, and a region of the first insulator are disposed along a direction, and wherein the light emitter is disposed on the first pad where the second insulator is absent and electrically connected to the second pad where the second insulator is absent.
2. The light emitting device of claim 1, wherein the non-luminous region is provided with conductive patterns electrically connected to the light emitter.
3. The light emitting device of claim 1, wherein the second pad comprises a region extended from the luminous region of the substrate.
4. The light emitting device of claim 3, wherein the region of the second pad overlaps a region of the non-luminous region of the substrate.
5. The light emitting device of claim 1, further comprising a conductive adhesive layer disposed on the first pad.
6. The light emitting device of claim 5, wherein the conductive adhesive layer is disposed between the first pad and the first electrode of the light emitter.
7. The light emitting device of claim 1, wherein the second pad is spaced apart from the light emitter and the luminous region of the substrate.
8. The light emitting device of claim 1, further comprising a terminal source disposed on the non-luminous region of the substrate and electrically connected to at least one of the first pad or the second pad.
9. The light emitting device of claim 1, further comprising at least one wavelength converter disposed above the luminous region.
10. A light emitting device comprising: a substrate having a first region and a second region; a light emitter disposed on the first region of the substrate, the light emitter including a first electrode and a second electrode; a window disposed on the substrate and configured to cover the first region, the window further configured to control a traveling path of light emitted from the light emitter; and a first pad and a second pad that are disposed on the first region to overlap at least a region to the light emitter, the first pad electrically coupled to first electrode of the light emitter and the second pad electrically coupled to the second electrode of the light emitter; a first insulator disposed on the substrate and configured to cover a region of an upper surface of the substrate; and a second insulator disposed on the second region of the substrate and configured to cover a region of the substrate except for the first region and cover a region of the second pad, wherein the second insulator, the region of the second pad, and a region of the first insulator are disposed along a direction, wherein the first insulator is disposed between the first pad and the second pad, wherein the second insulator covers a region of an upper surface of the second pad, and the light emitter is

disposed on the first pad where the second insulator is absent and electrically connected to the second pad where the second insulator is absent.

11. The light emitting device of claim 10, wherein a first light emitted from the first light has a first light pattern and a second light emitted from the light emitting device has a second light pattern.

12. The light emitting device of claim 11, wherein the first light pattern is different from the second light pattern.

13. The light emitting device of claim 10, further comprising a conductive adhesive layer disposed between the first pad and the first electrode of the light emitter.

14. The light emitting device of claim 10, further comprising a terminal source disposed on the second region of the substrate and electrically connected to at least one of the first pad or second pad.

15. A light emitting device comprising: a substrate including a luminous region and a non-luminous region; a light emitter disposed on the luminous region of the substrate and including a first electrode and a second electrode; a window disposed on the substrate and configured to cover the luminous region, the window configured to control a traveling path of light emitted from the light emitter; a first pad and a second pad that are disposed on the substrate, the first pad electrically coupled to the first electrode of the light emitter and the second pad electrically coupled to the second electrode of the light emitter; a first insulator disposed between the first pad and the second pad; and a second insulator disposed on the substrate and configured to cover a region of the substrate except for the luminous region and cover a region of the second pad, wherein the second insulator, the region of the second pad, and a region of the first insulator are disposed along a direction, wherein the light emitter is disposed on the first pad to which the second insulator is not provided and electrically connected to the second pad to which the second insulator is not provided.

16. The light emitting device of claim 15, wherein the non-luminous region is provided with a conductive pattern electrically connected to the light emitter.

17. The light emitting device of claim 15, further comprising at least one wavelength converter disposed above the luminous region.

18. The light emitting device of claim 15, wherein a first light emitted from the light emitter has a first light pattern and a second light emitted from the light emitting device has a second light pattern.

19. The light emitting device of claim 18, wherein the first light pattern is different from the second light pattern.

20. The light emitting device of claim 15, further comprising a terminal source disposed on the non-luminous region.
